

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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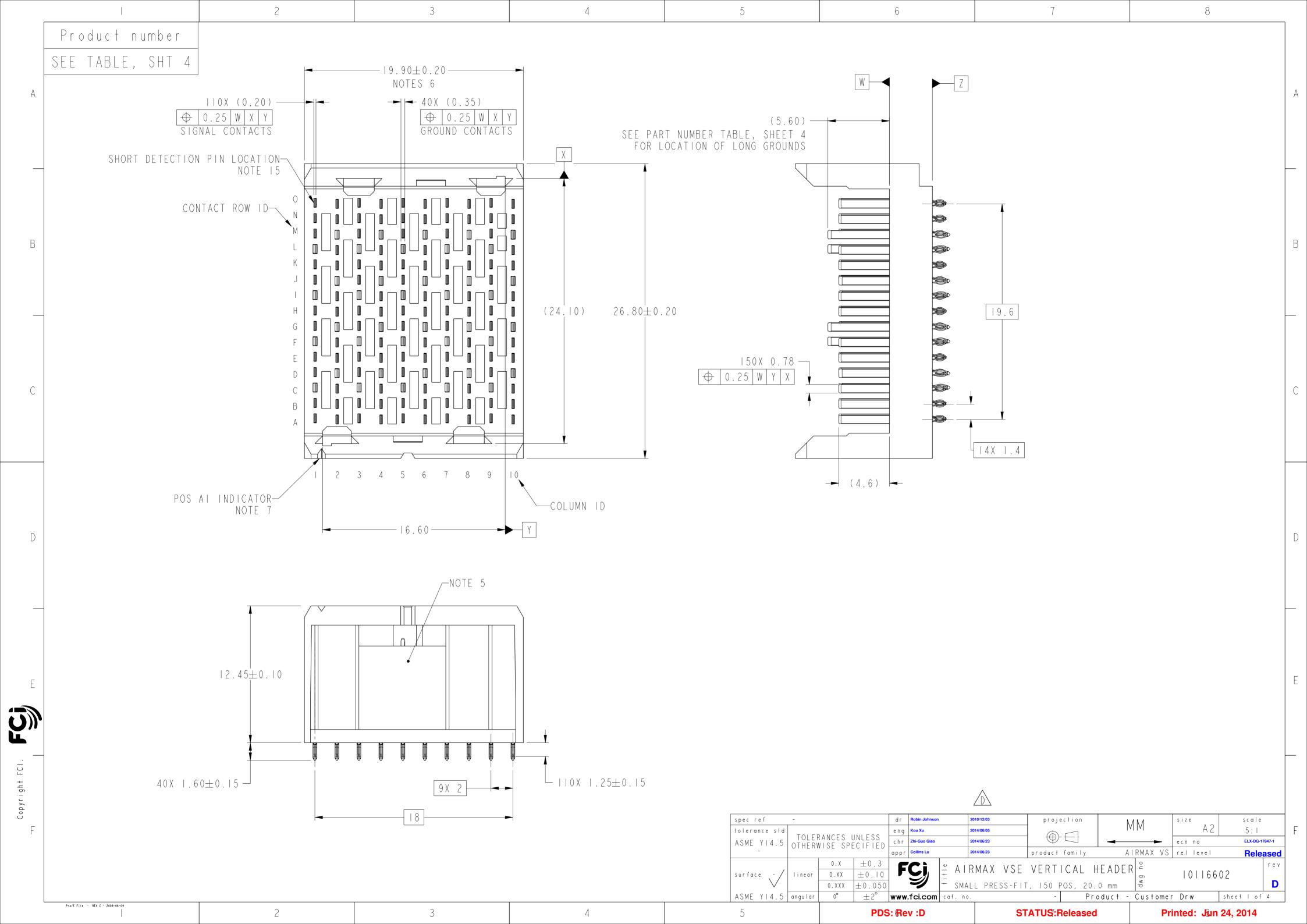
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

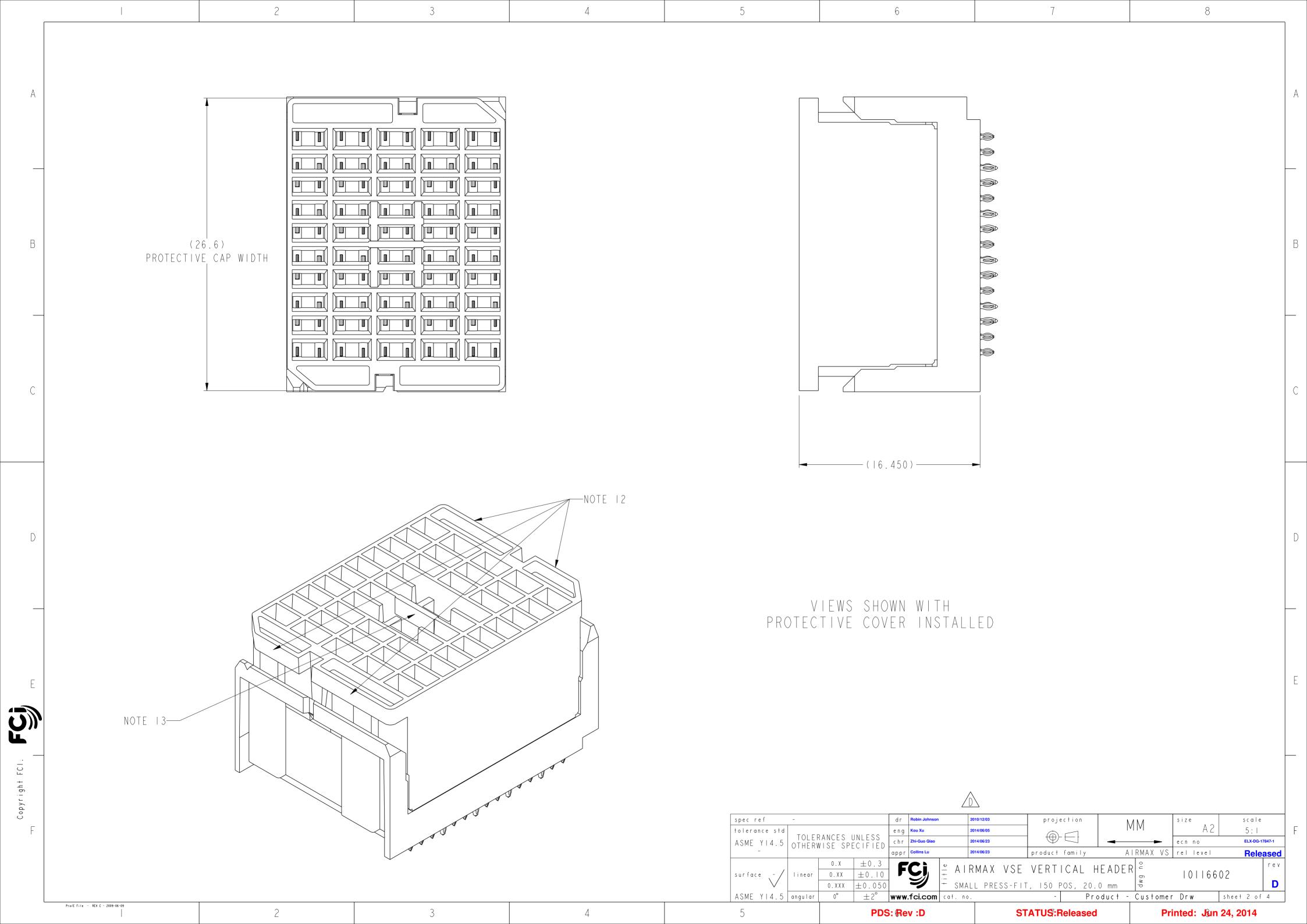
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

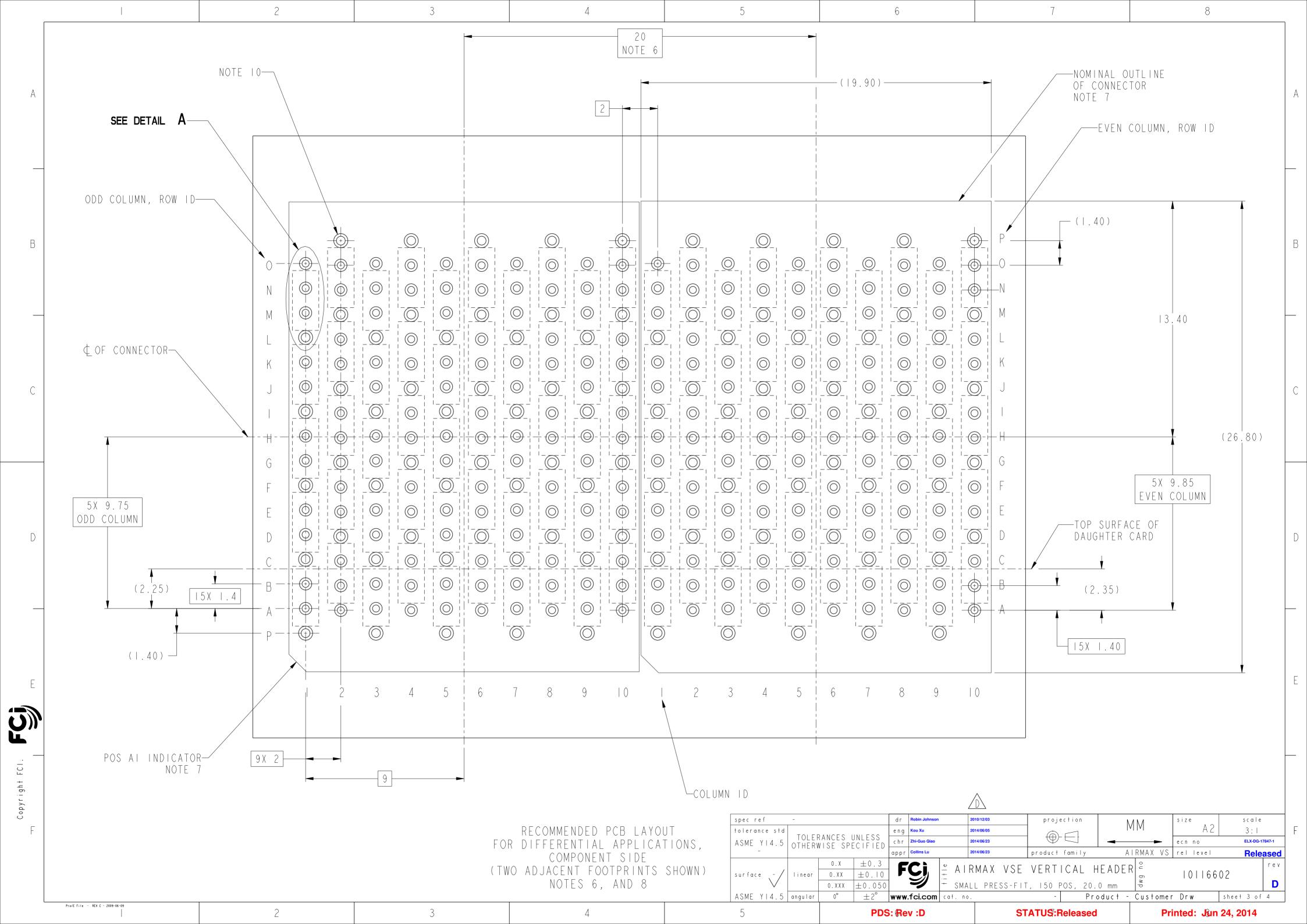




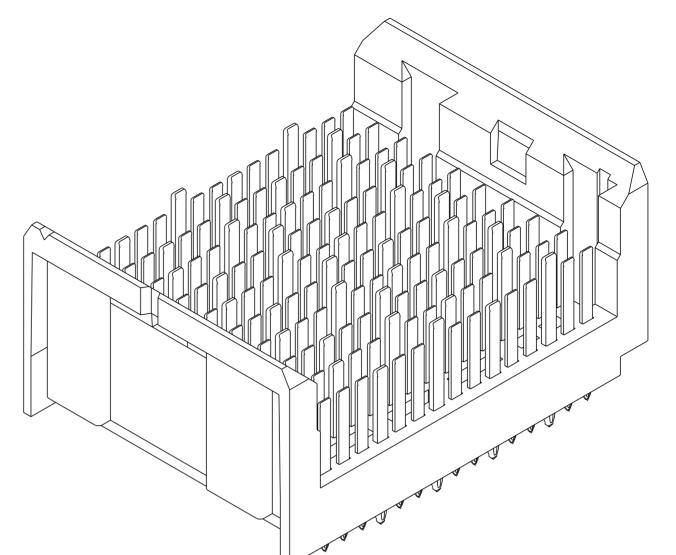








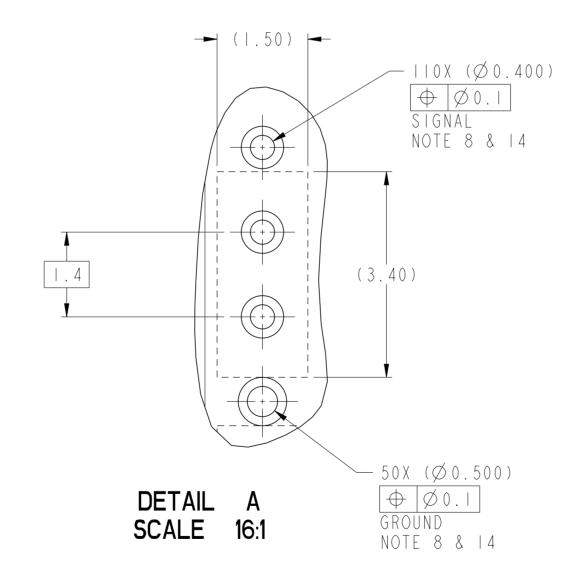
	I		2		3			4			5	
А	PART NUMBER	PRESS-FIT PLATING T		'ER	LONG GROUND PIN LO			ATION	S (5.6MM)		REMARK	
	10116602-101LF	TIN OVEI NICKEL (LEAD FRE	YES		LI, M2, L3, FI, G2, F3,						T SHORT DETECTION PIN	
	10116602-111LF	TIN OVEI NICKEL (LEAD FRE	YES		LI, M2, L3, FI, G2, F3,						SHORT DETECTION PIN	
_	NOTES:  I. CONNECTOR MATERIALS: HOUSING: HIGH TEMP THERMOPLASTIC, BLACK, UL94V-0 CONTACT: COPPER ALLOY											
В	2. CONTACT PLATING: SEPARABLE INTERFACE: PERFORMANCE-BASED PLATING, QUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-I2-XXX INCLUDING TELCORDIA GR-I2I7-CORE (NOVEMBER 1995) CENTRAL OFFICE TEST SEQUENCE PRESS-FIT TAILS: SEE TABLE											
	3. PRODUCT SPECIFICATION: GS-12-239.											
	4. APPLICATION SPECIFICATION: GS-20-035											

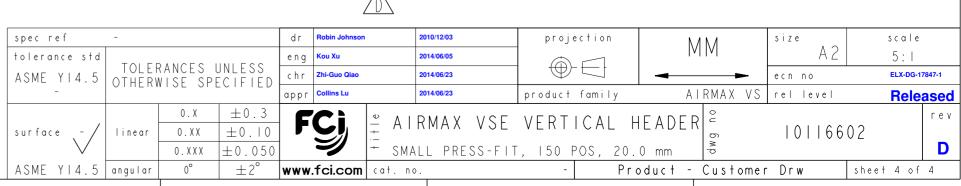


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10116602-101LF

- (5.) PRODUCT MARKING, (PROTOTYPE, PART NUMBER & LOT CODE), ON THIS SURFACE.
- (6.) THE MINIMUM CENTERLINE SPACING BETWEEN ADJACENT MODULES IS 20.0 mm.
- 7.) CONNECTOR OUTLINE WITH HOUSING POS AT INDICATOR MAY BE SCREEN PRINTED ONTO CUSTOMER PCB TO BE USED AS A GUIDE FOR MANUAL CONNECTOR PLACEMENT.
- 8. REFER TO CUSTOMER DRAWING 10104444 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLATING OPTIONS.
- 9. LEAD FREE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- (0) THE OUTER VIAS IN COLUMN PARE OPTIONAL. IF ADDED THESE HOLES PROVIDE GROUND SYMETRY THROUGH THE PCB. NO CONNECTOR EONS WILL BE PRESSED INTO THESE HOLES.
- II. PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION.
- (12) FOR REMOVAL OF THE PROTECTIVE CAP BY HAND, GRIP USING THESE SURFACES.
- (13) FOR REMOVAL OF THE PROTECTIVE CAP WITH PLIERS, GRIP USING THIS FEATURE.
- GROUND VIAS IN POSITIONS C, F, I, L & P FOR ODD COLUMNS AND POSITIONS D, G, J, M & P FOR EVEN COLUMNS REQUIRE (Ø 0.50) FINISHED HOLES. ALL OTHER VIAS REQUIRE (Ø 0.40) FINISHED HOLES.
- 15. SHORT DETECTION PIN OI IS 0.50mm LESS WIPE NOMINAL THAN THE SHORTEST PIN.
- 16. A D SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEM OR NOTE.
  THAT HAD BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.





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